



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
 United States Patent and Trademark Office
 Address: COMMISSIONER FOR PATENTS
 P.O. Box 1450
 Alexandria, Virginia 22313-1450
 www.uspto.gov



Bib Data Sheet

CONFIRMATION NO. 6113

SERIAL NUMBER 10/623,772	FILING DATE 07/22/2003 RULE	CLASS 438	GROUP ART UNIT 2813	ATTORNEY DOCKET NO. 402715
-----------------------------	---------------------------------------	--------------	------------------------	----------------------------------

APPLICANTS

Teruhiko Kumada, Tokyo, JAPAN;

Toshiyuki Toyoshima, Tokyo, JAPAN;

Hideharu Nobutoki, Tokyo, JAPAN; Takeo Ishibashi, Tokyo, JAPAN;

Yoshiharu Ono, Tokyo, JAPAN;

Junjiro Sakai, Tokyo, JAPAN;

** CONTINUING DATA *****

** FOREIGN APPLICATIONS *****

JAPAN 2002-274300 09/20/2002

JAPAN 2003-033316 02/12/2003

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 02/27/2004

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR	SHEETS	TOTAL	INDEPENDENT
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance	COUNTRY	DRAWING	CLAIMS	CLAIMS
Verified and Acknowledged <i>[Signature]</i> Examiner's Signature Initials	JAPAN	3	14	3

ADDRESS

23548

LEYDIG VOIT & MAYER, LTD

700 THIRTEENTH ST. NW

SUITE 300

WASHINGTON, DC

20005-3960

TITLE

Via-filling material and process for fabricating semiconductor integrated circuit using the material

FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time)
------------	---	--